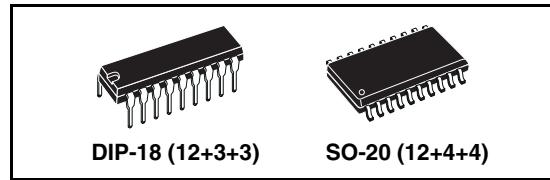


## 3.5A step down switching regulator

### General features

- Up to 3.5A step down converter
- Operating input voltage from 8V to 55V
- 3.3V and 5.1V ( $\pm 1\%$ ) fixed output, and adjustable outputs from:
  - 0.5V to 50V (3.3 type)
  - 5.1V to 50V (5.1 type)
- Frequency adjustable up to 300kHz
- Voltage feed forward
- Zero load current operation (min 1mA)
- Internal current limiting (pulse by pulse and HICCUP mode)
- Precise 5.1V (1.5%) reference voltage externally available
- Input/output synchronization function
- Inhibit for zero current consumption (100mA typ. at  $V_{CC} = 24V$ )
- Protection against feedback disconnection
- Thermal shutdown
- Output overvoltage protection
- Soft start function



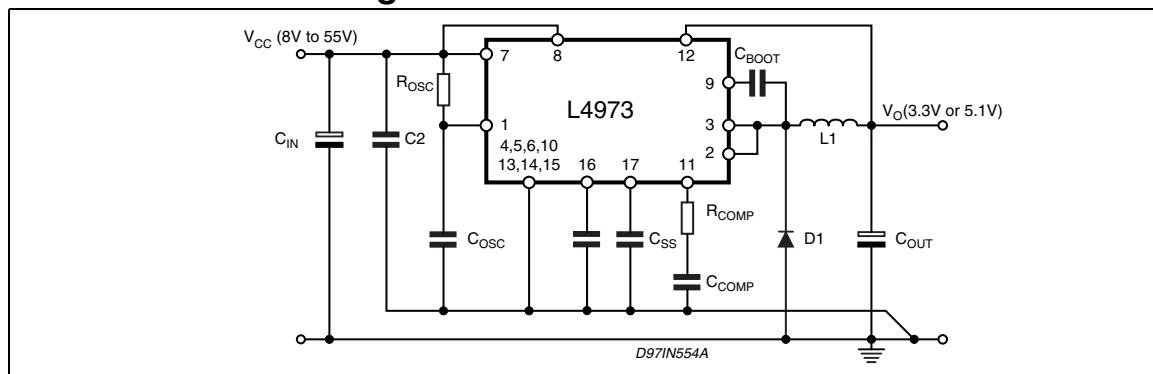
### Description

The L4973 is a step down monolithic power switching regulator delivering 3.5A at fixed voltages of 3.3V or 5.1V and using a simple external divider output adjustable voltage up to 50V. Realized in BCD mixed technology, the device uses an internal power D-MOS transistor (with a typical  $R_{DS(on)}$  of  $0.15\Omega$ ) to obtain very high efficiency and very fast switching times. Switching frequency up to 300KHz are achievable (the maximum power dissipation of the packages must be observed).

A wide input voltage range between 8V to 55V and output voltages regulated from 3.3V to 40V cover the majority of the today applications. Features of this new generation of DC-DC converter includes pulse by pulse current limit, hiccup mode for output short circuit protection, voltage feed forward regulation, soft start, input/output synchronization, protection against feedback loop disconnection, inhibit for zero current consumption and thermal shutdown.

Packages available are in plastic dual in line, DIP-18 (12+3+3) for standard assembly, and SO20 (12+4+4) for SMD assembly.

### Internal schematic diagram

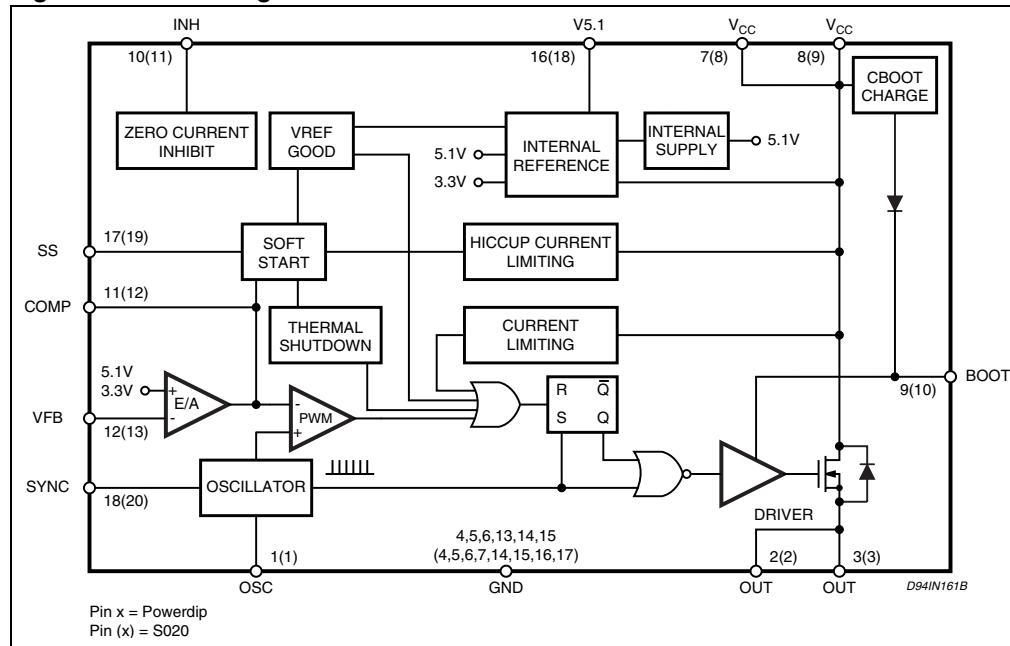


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# 1 Block diagram

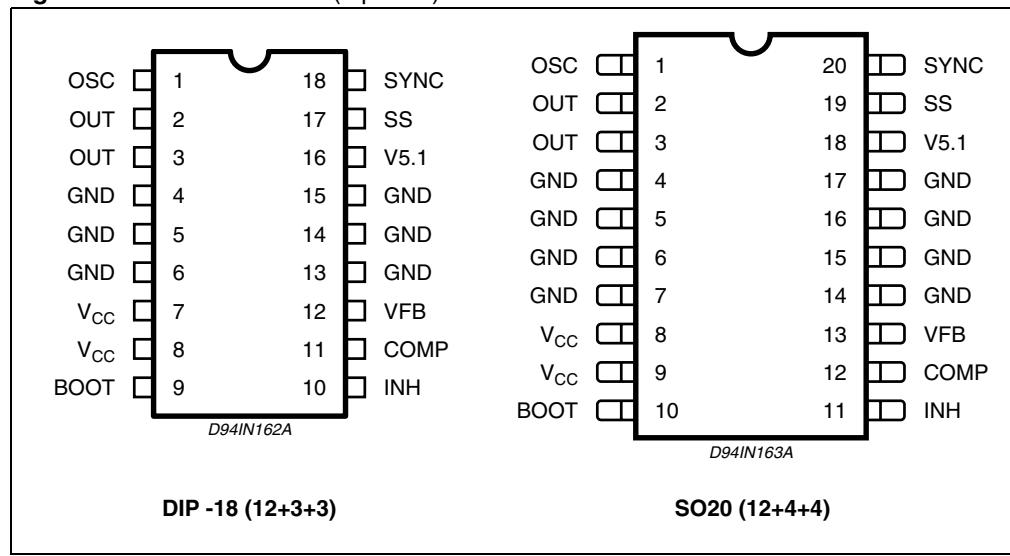
**Figure 1. Block diagram**



# 2 Pin settings

## 2.1 Pin connection

**Figure 2. Pin connection (top view)**



## 2.2 Pin description

**Table 1. Pin description**

N° Pin		Name	Description
DIP-18	SO-20		
11	12	COMP	E/A output to be used for frequency compensation
10	11	INH	A logic signal (active high) disables the device (sleep mode operation). If not used it must be connected to GND; if floating the device is disabled.
9	10	BOOT	A capacitor connected between this pin and the output allows to drive the internal D-MOS.
18	20	SYNC	Input/Output synchronization.
7,8	8,9	V <sub>CC</sub>	Unregulated DC input voltage
2,3	2,3	OUT	Stepdown regulator output.
12	13	VFB	Stepdown feedback input. Connecting the output directly to this pin results in an output voltage of 3.3V for the L4973V3.3 and 5.1V for L4973V5.1. An external resistive divider is required for higher output voltages. For output voltage resistive divider is required for higher output voltages. For output voltage less than 3.3V, see <i>Note: 1</i> and <i>Figure 32</i> .
16	18	V5.1	Reference voltage externally available.
4,5,6 13,14,15	4,5,6,7 14,15,16,17	GND	Signal ground
1	1	OSC	An external resistor connected between the unregulated input voltage and Pin 1 and a capacitor connected from Pin 1 to ground fixes the switching frequency. (Line feed forward is automatically obtained)

*Note:* 1 The maximum power dissipation of the package must be observed.

### 3 Electrical data

#### 3.1 Maximum ratings

**Table 2. Absolute maximum ratings**

Symbol		Parameter	Value	Unit
DIP-18	SO-20			
V <sub>7,V<sub>8</sub></sub>	V <sub>9,V<sub>8</sub></sub>	Input voltage	58	V
V <sub>2,V<sub>3</sub></sub>	V <sub>2,V<sub>3</sub></sub>	Output DC voltage Output peak voltage at t = 0.1μs f = 200KHz	-1 - 5	V V
I <sub>2,I<sub>3</sub></sub>	I <sub>2,I<sub>3</sub></sub>	Maximum output current	int. limit.	
V <sub>9-V<sub>8</sub></sub>	V <sub>10-V<sub>8</sub></sub>		14	V
V <sub>9</sub>	V <sub>10</sub>	Bootstrap voltage	70	V
V <sub>11</sub>	V <sub>12</sub>	Analogs input voltage (V <sub>CC</sub> = 24V)	12	V
V <sub>17</sub>	V <sub>19</sub>	Analogs input voltage (V <sub>CC</sub> = 24V)	13	V
V <sub>12</sub>	V <sub>13</sub>	(V <sub>CC</sub> = 20V)	6 -0.3	V V
V <sub>18</sub>	V <sub>20</sub>	(V <sub>CC</sub> = 20V)	5.5 0.3	V V
V <sub>10</sub>	V <sub>11</sub>	Inhibit	V <sub>CC</sub> -0.3	V V
P <sub>tot</sub>	DIP 12+3+3 Power dissipation a T <sub>pins</sub> ≤ 90°C (T <sub>A</sub> = 70°C no copper area) (T <sub>A</sub> = 70°C 4cm copper area on PCB)			5 1.3 2
	SO-20 Power dissipation a T <sub>pins</sub> = 90°C			4
T <sub>J,T<sub>STG</sub></sub>	Junction and storage temperature			-40 to 150 °C

#### 3.2 Thermal data

**Table 3. Thermal data**

Symbol	Parameter	DIP-18	SO-20	Unit
R <sub>thJP</sub>	Maximum thermal resistance junction-pin	12	15	°C/W
R <sub>thJA</sub>	Maximum thermal resistance junction-ambient	60 <sup>(1)</sup>	80 <sup>(1)</sup>	°C/W

1. Package mounted on board

## 4 Electrical characteristics

**Table 4. Electrical characteristics**(Refer to the test circuit,  $V_{CC} = 24V$ ;  $T_J = 25^\circ C$ ,  $C_{OSC} = 2.7nF$ ;  $R_{OSC} = 20K\Omega$ ; unless otherwise specified)

Symbol	Parameter	Test Condition		Min	Typ	Max	Unit
<b>Dynamic characteristics</b>							
	Input Voltage Range (1)	$V_O = V_{REF}$ to 40V; $I_O = 3.5A$	(2)	8		55	V
	Output Voltage L4973V5.1	$I_O = 1A$		5.05	5.1	5.15	V
		$I_O = 0.5A$ to 3.5A $V_{CC} = 8V$ to 55V		5.00	5.1	5.20	V
	Output Voltage L4973V3.3	$I_O = 1A$		3.326	3.36	3.393	V
		$I_O = 0.5A$ to 3.5A $V_{CC} = 8V$ to 40V		3.292	3.36	3.427	V
			(2)	3.26	3.36	3.46	V
	$R_{DS(on)}$	$V_{CC} = 10.5V$ $I_O = 3.5A$			0.15	0.22	W
			(2)			0.35	W
	Maximum Limiting Current	$V_{CC} = 8V$ to 55V	(2)	4	4.5	5.5	A
h	Efficiency	$V_O = 5.1V$ ; $I_O = 3.5A$			90		%
		$V_O = 3.3V$ ; $I_O = 3.5A$			85		%
	Switching Frequency		(2)	90	100	110	KHz
	Supply Voltage Ripple Rejection	$V_i = V_{CC}+2V_{RMS}$ $V_O = V_{ref}$ ; $I_O = 1A$ ; $f_{ripple} = 100Hz$		60			dB
$\Delta f_{sw}$	Switching Frequency Stability vs. Supply Voltage	$V_{CC} = 8V$ to 55V			2	5	%
<b>Reference section</b>							
	Reference Voltage	$I_{ref} = 0$ to 20mA; $V_{CC} = 8$ to 55V		5.025	5.1	5.175	V
			(2)	4.950	5.1	5.250	V
	Line Regulation	$I_{ref} = 0mA$ ; $V_{CC} = 8$ to 55V			5	10	mV
	Load Regulation	$V_{ref} = 0$ to 5mA; $V_{CC} = 0$ to 20mA			2	10	mV mV
	Short Circuit Current			30	65	100	mA

**Table 4. Electrical characteristics (continued)**(Refer to the test circuit,  $V_{CC} = 24V$ ;  $T_J = 25^\circ C$ ,  $C_{OSC} = 2.7nF$ ;  $R_{OSC} = 20K\Omega$ ; unless otherwise specified)

Symbol	Parameter	Test Condition	Min	Typ	Max	Unit
<b>Soft start</b>						
	Soft Start Charge Current		30	45	60	$\mu A$
	Soft Start Discharge Current		15	22	30	$\mu A$
<b>Inhibit</b>						
	High Level Voltage		(2)	3.0		V
	Low Level Voltage		(2)			0.8 V
	$I_{source}$ High Level	$V_{INH} = 3V$	(2)	10	16	$\mu A$
	$I_{source}$ Low Level	$V_{INH} = 0.8V$	(2)	10	15	$\mu A$
<b>DC characteristics</b>						
	Total Operating Quiescent Current	Duty Cycle = 50%		4	6	mA
	Quiescent Current	Duty Cycle = 0		2.7	4	mA
	Total stand-by quiescent current	$V_{CC} = 24V$ ; $V_{INH} = 5V$		100	200	$\mu A$
		$V_{CC} = 55V$ ; $V_{INH} = 5V$		150	300	$\mu A$
<b>Error amplifier</b>						
	High Level Output Voltage		11.0			V
	Low Level Output Voltage				0.65	V
	Source Bias Current		1	2	3	$\mu A$
	Source Output Current		200	300	600	$\mu A$
	Sink Output Current		200	300		$\mu A$
	Supply Voltage Ripple Rejection	$V_{COMP} = V_{FB}$ $C_{REF} = 4.7mF$ 1-5mA load current	60	80		dB
	DC Open Loop Gain	$R_L = \infty$	50	60		dB
	Transconductance	$I_{comp} = -0.1$ to $0.1mA$ ; $V_{comp} = 6V$		2.5		mS
<b>Oscillator section</b>						
	Ramp valley		0.78	0.85	0.92	V

**Table 4. Electrical characteristics** (continued)(Refer to the test circuit,  $V_{CC} = 24V$ ;  $T_J = 25^{\circ}C$ ,  $C_{OSC} = 2.7nF$ ;  $R_{OSC} = 20K\Omega$ ; unless otherwise specified)

Symbol	Parameter	Test Condition	Min	Typ	Max	Unit
	Ramp peak	$V_{CC} = 8V$ $V_{CC} = 55V$	1.9 9	2.1 9.6	2.3 10.2	V V
	Maximum Duty Cycle		95	97		%
	Maximum Frequency	Duty Cycle = 0%; $R_{OSC} = 13K\Omega$ ; $C_{OSC} = 820pF$ ;			300	KHz
<b>Sync function</b>						
	High Input Voltage	$V_{CC} = 8V$ to $55V$	3.5			V
	Low Input Voltage	$V_{CC} = 8V$ to $55V$			0.9	V
	Slave Sink Current		0.15	0.25	0.45	mA
	Master Output Amplitude	$I_{source} = 3mA$	4	4.5		V
	Output Pulse Width	no load, $V_{sync} = 4.5V$	0.20	0.35		$\mu s$

1. Pulse testing with a low duty cycle
2. Specifications referred to  $T_J$  from 0 to  $125^{\circ}C$

## 5 Evaluation board

Figure 3. Evaluation board circuit

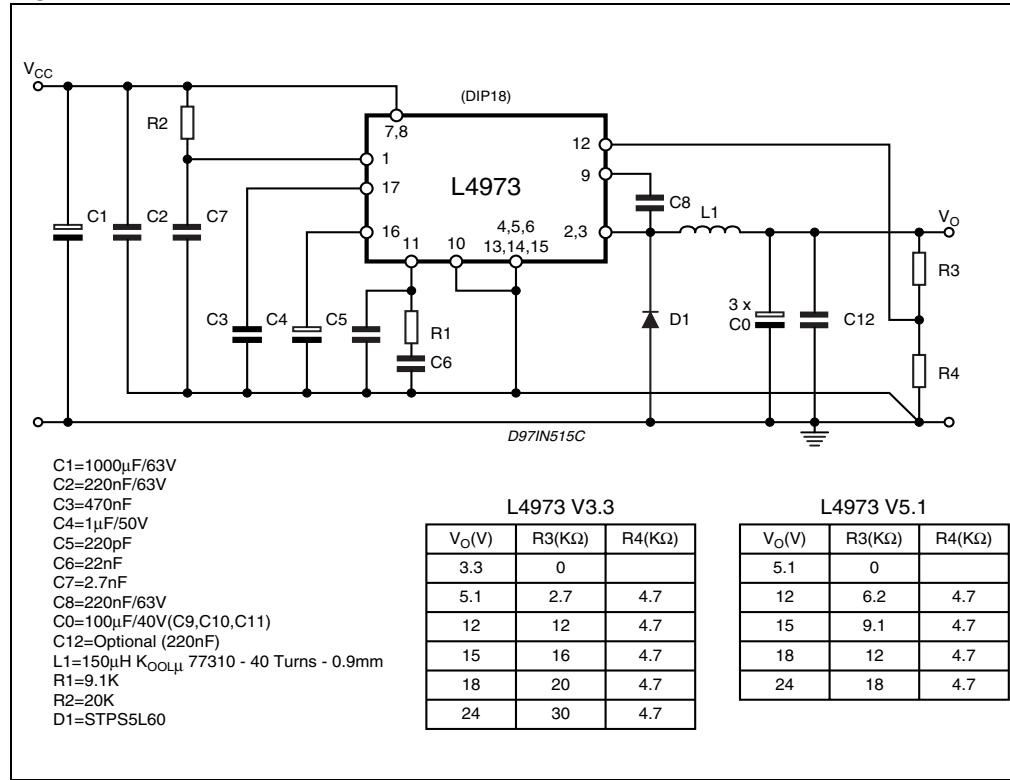
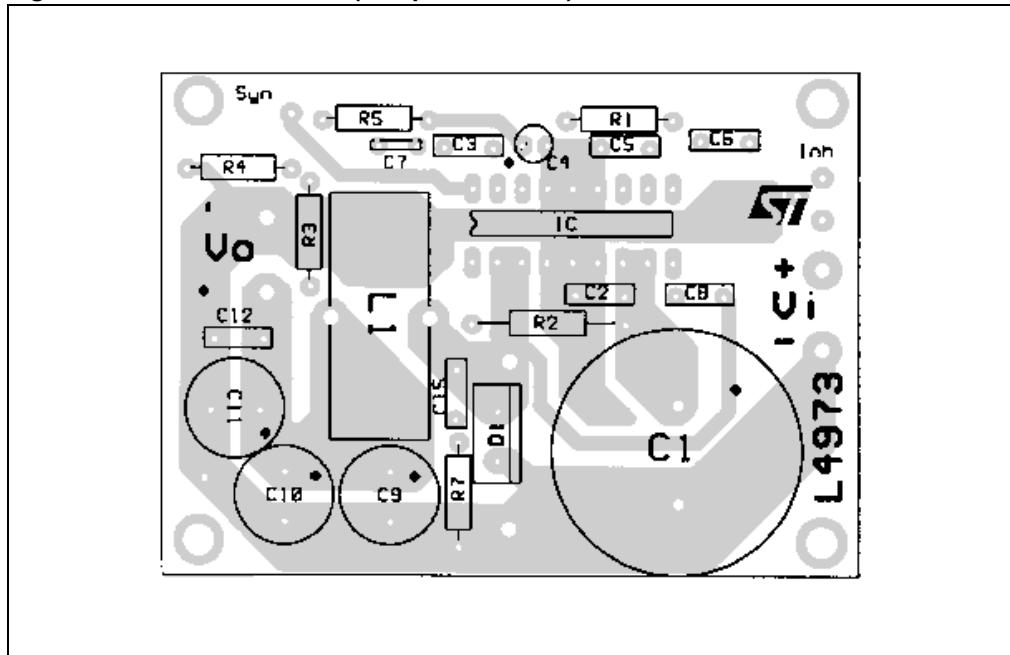
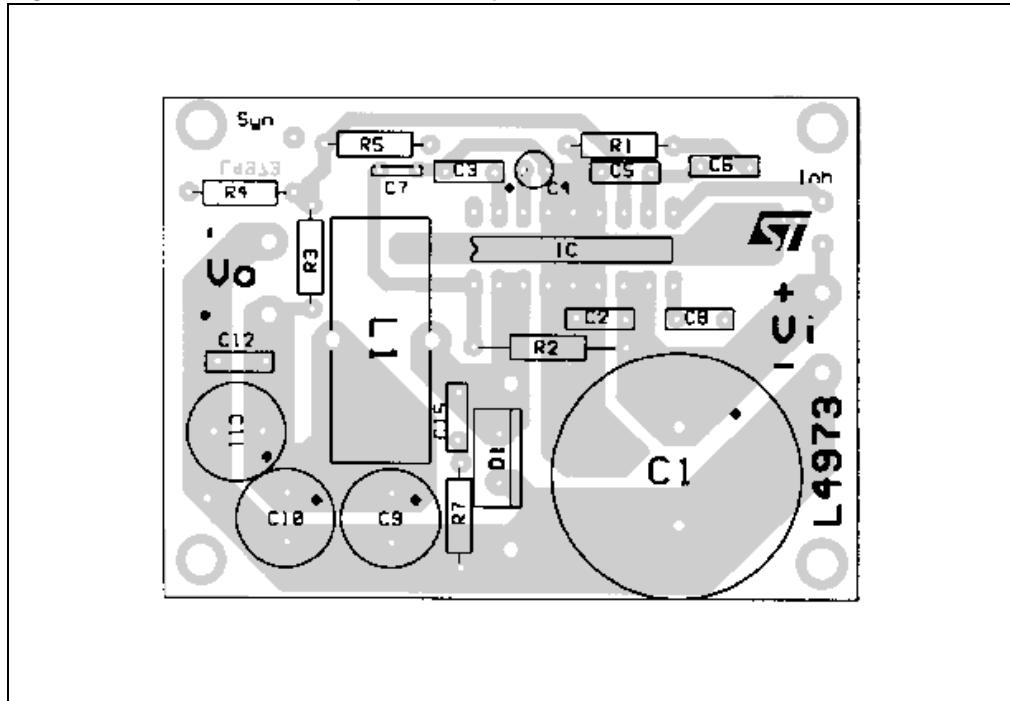


Table 5. Typical performance (using evaluation board)  $f_{SW} = 100\text{kHz}$

Output Voltage	Output Ripple	Efficiency	Line Regulator $I_o = 3.5A$ $V_{CC} = 8$ to $50V$	Load Regulator $V_{CC} = 35V$ $I_o = 1$ to $3.5A$
3.3V	20mV	81.5 (%)	3mV	6mV
5.1V	20mV	86.7 (%)	3mV	6mV
12V	30mV	93.5 (%)	3mV ( $V_{CC} = 15$ to $50V$ )	4mV

**Figure 4.** Evaluation board (components side)**Figure 5.** Evaluation board (solder side)

## 6 Application circuit

Figure 6. Application circuit (see [Figure 3 part list](#))

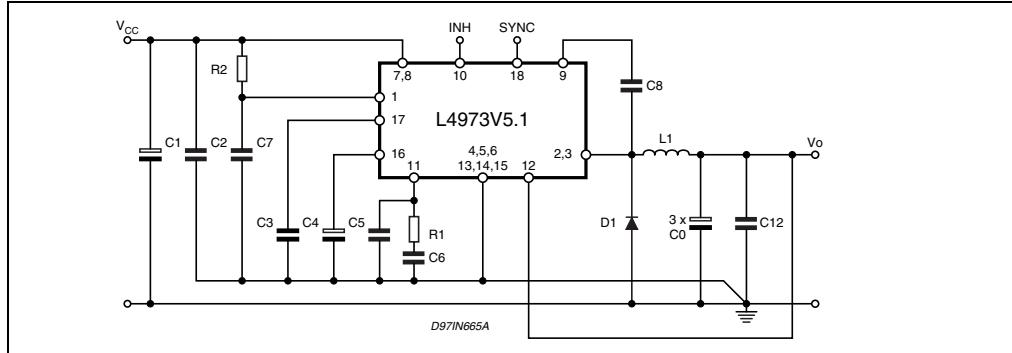
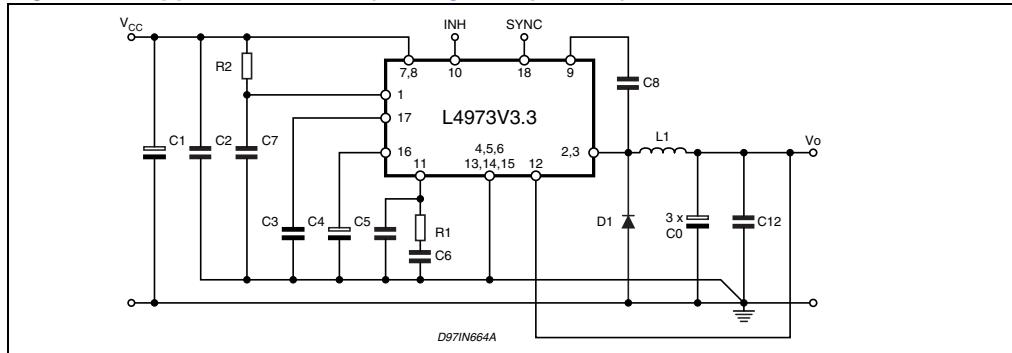
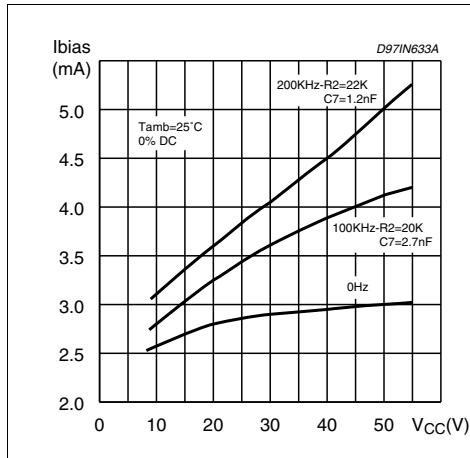


Figure 7. Application circuit (see [Figure 3 part list](#))

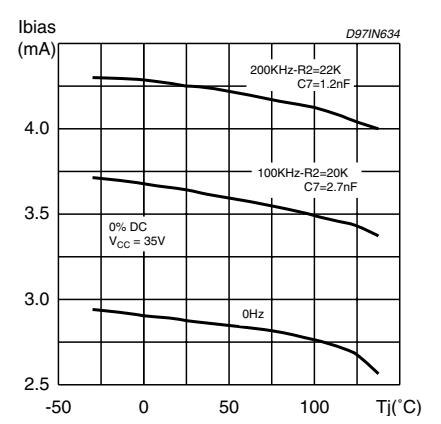


## 7 Typical characteristics

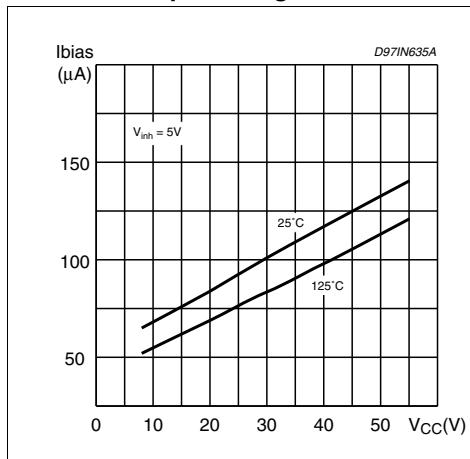
**Figure 8. Quiescent drain current vs. input voltage (0% duty cycle)**



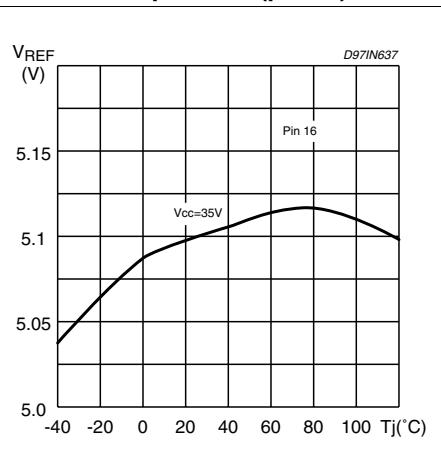
**Figure 9. Quiescent drain current vs. junction temperature**



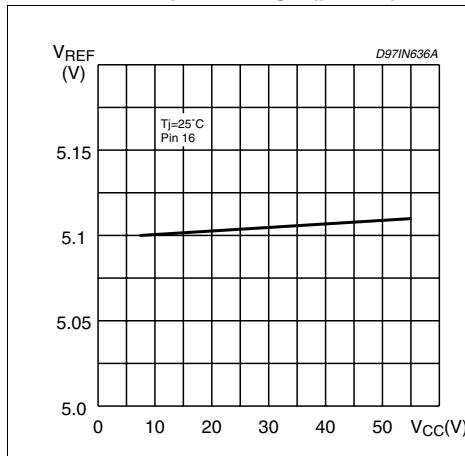
**Figure 10. Stand by drain current vs. input voltage**



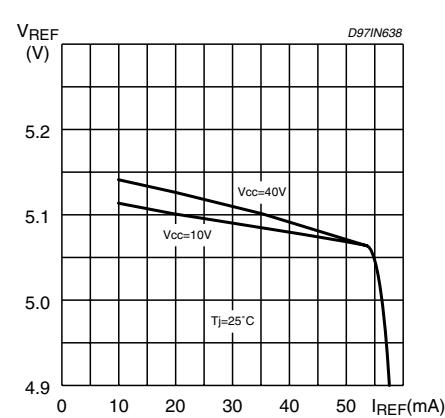
**Figure 11. Reference voltage vs. junction temperature (pin 16)**



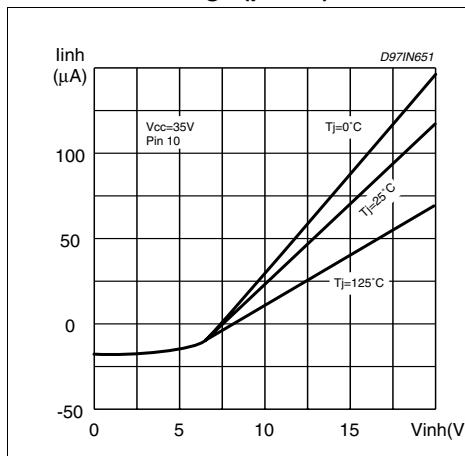
**Figure 12. Reference voltage vs. input voltage (pin 16)**



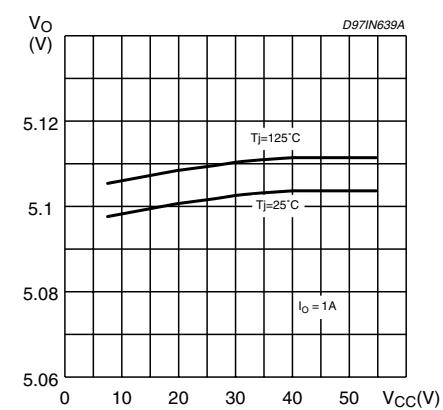
**Figure 13. Reference voltage vs. reference input current**



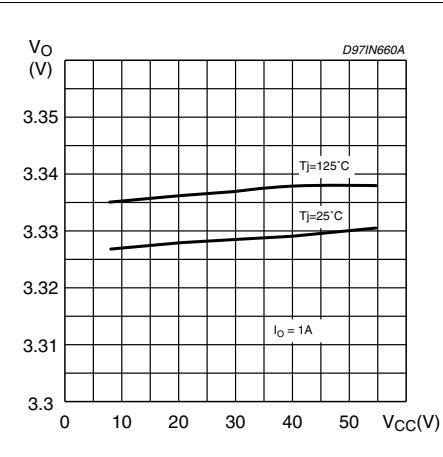
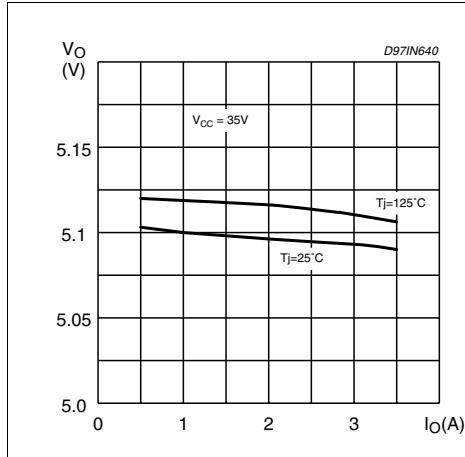
**Figure 14. Inhibit current vs. inhibit voltage (pin 10)**



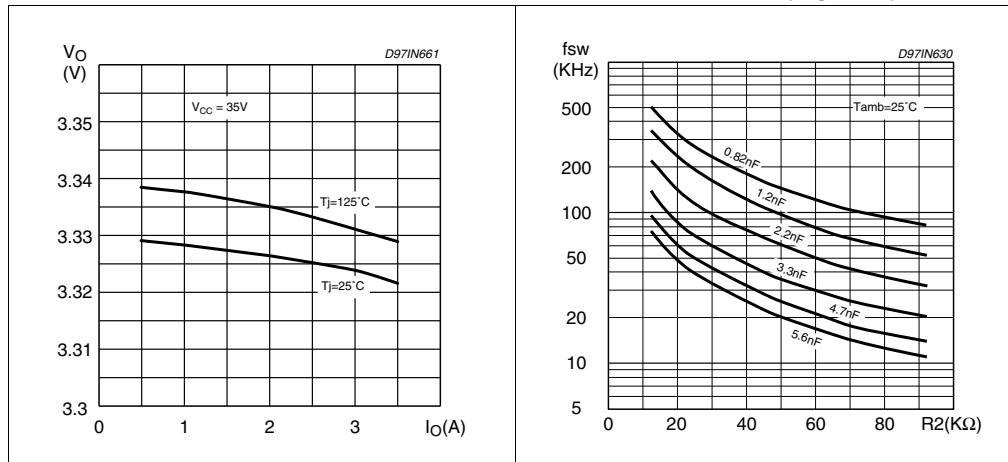
**Figure 15. Line regulation (see Figure 6)**



**Figure 16. Load regulation (see Figure 6) Figure 17. Line regulation (see Figure 7)**

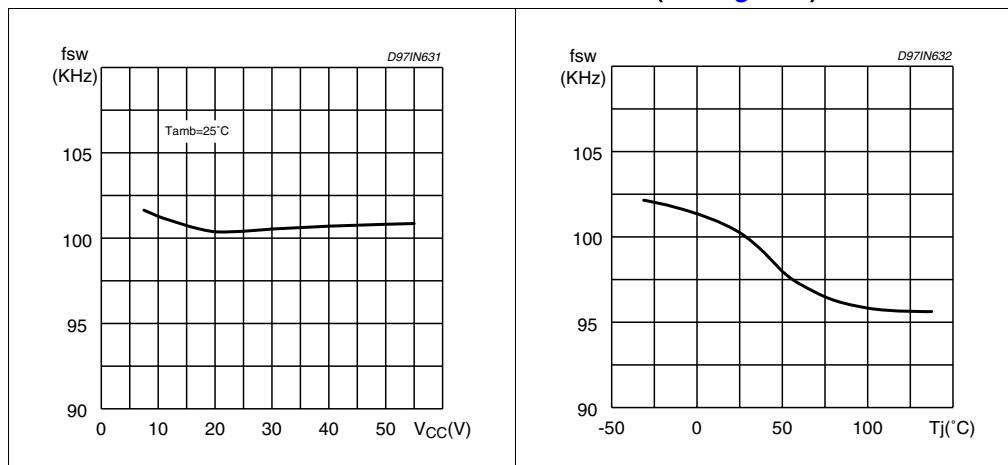


**Figure 18. Load regulation (see [Figure 3](#))** **Figure 19. Switching frequency vs. R2 and C7 ([Figure 3](#))**

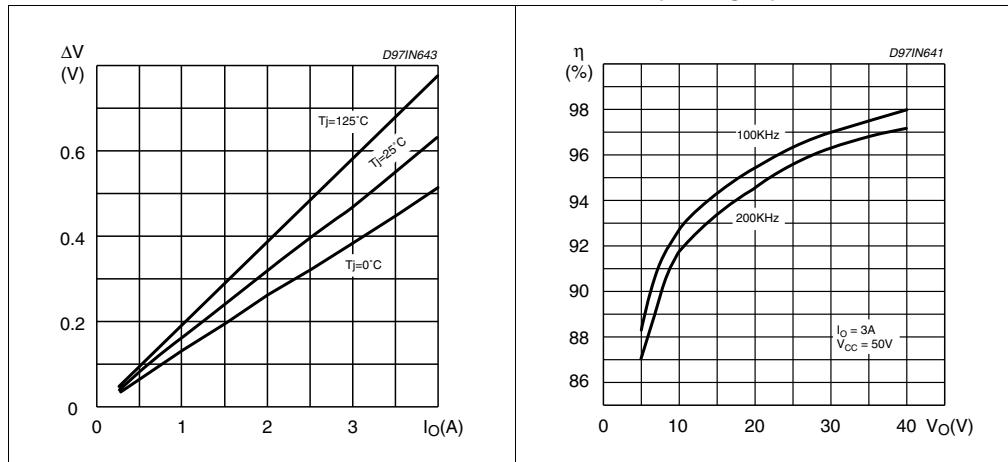


**Figure 20. Switching frequency vs. input voltage**

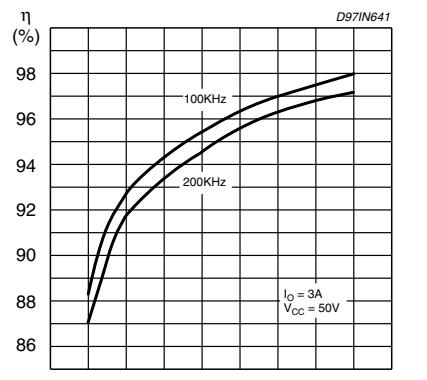
**Figure 21. Switching frequency vs. junction temperature (see [Figure 3](#))**



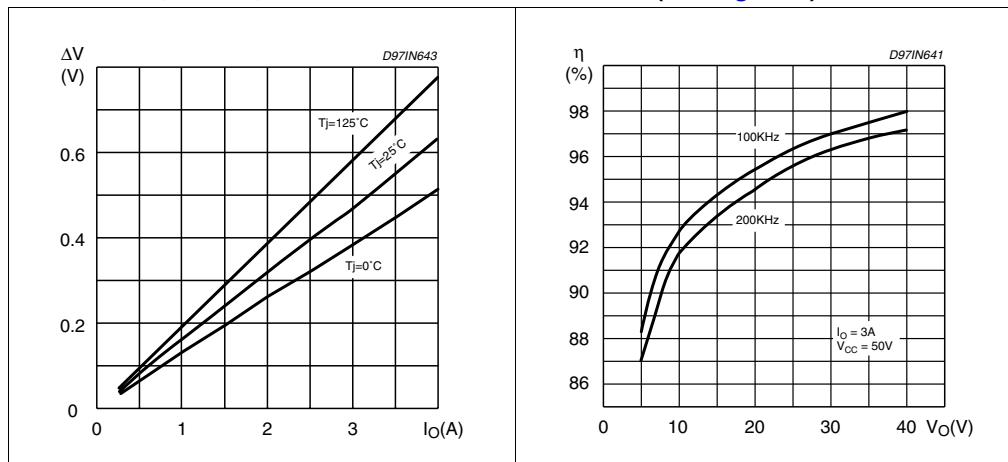
**Figure 22. Dropout voltage between pin 7,8 and 2,3**



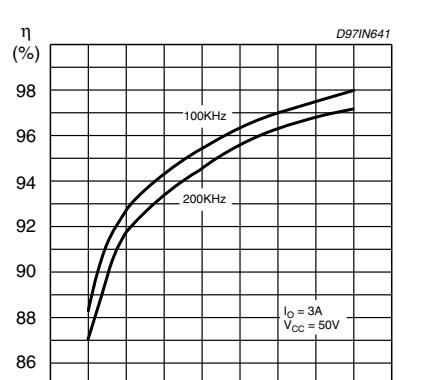
**Figure 23. Efficiency vs. output voltage (see fig. 5)**



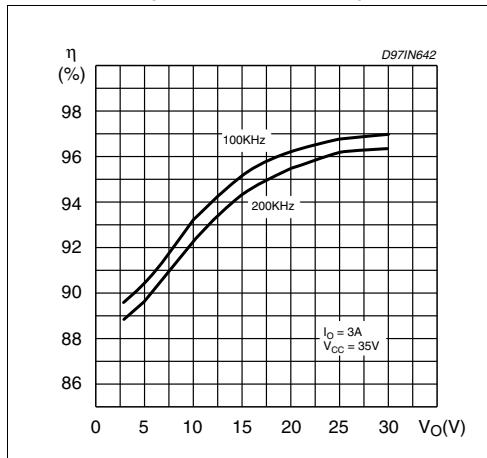
**Figure 24. Dropout voltage between pin 7,8 and 2,3**



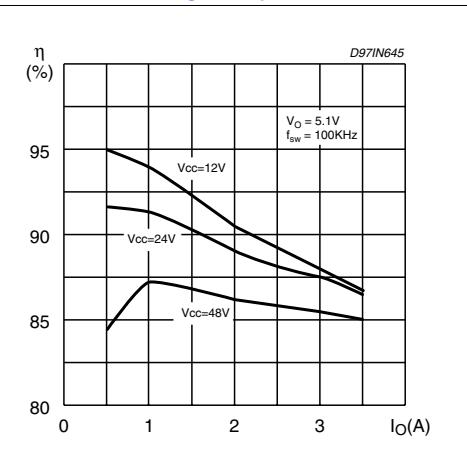
**Figure 25. Efficiency vs. output voltage (see Figure 3)**



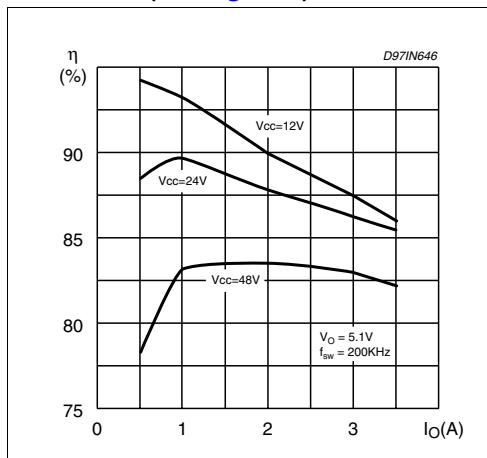
**Figure 26. Efficiency vs. output voltage  
(Diode STPS745D)**



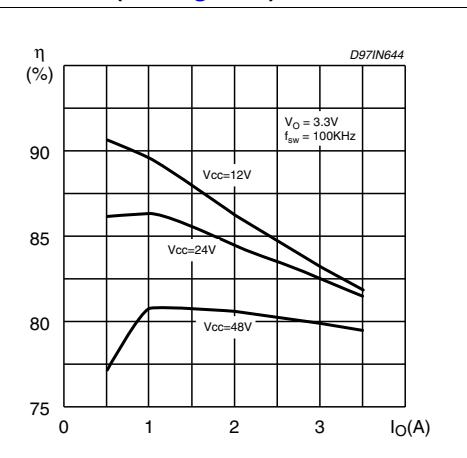
**Figure 27. Efficiency vs. output current (see Figure 6)**



**Figure 28. Efficiency vs. output current  
(see Figure 6)**

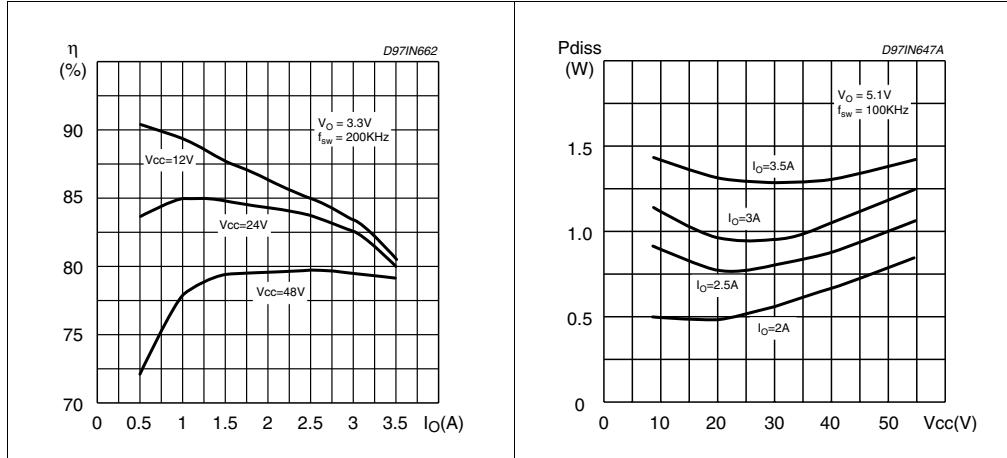


**Figure 29. Efficiency vs. output current  
(see Figure 7)**



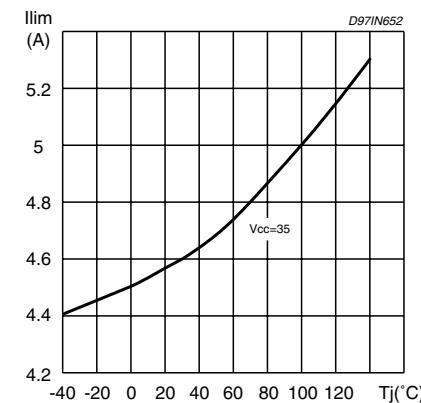
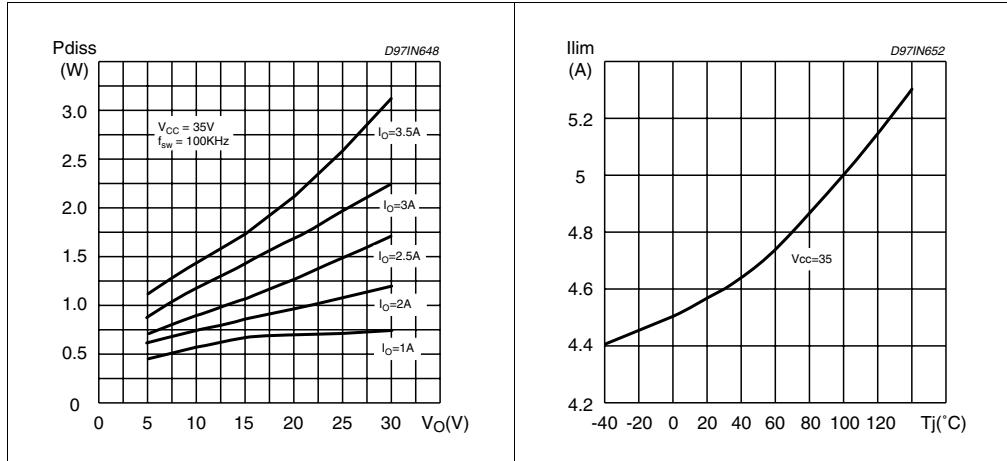
**Figure 30. Efficiency vs. output current  
(see [Figure 7](#))**

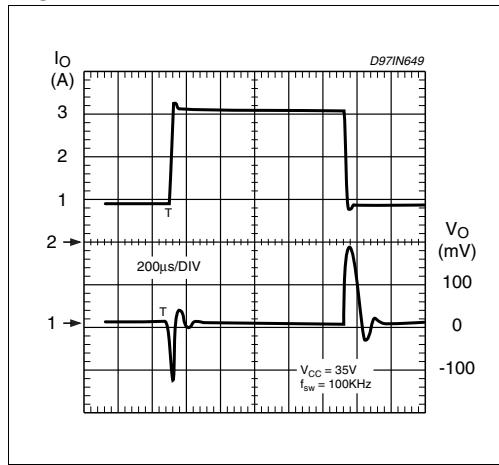
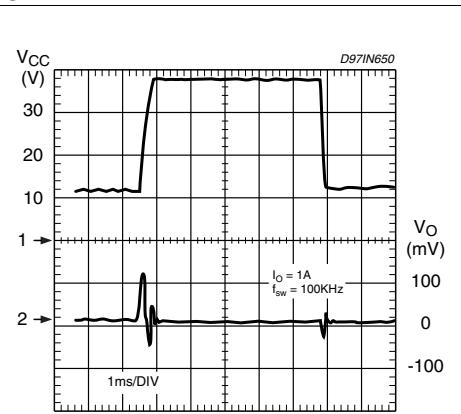
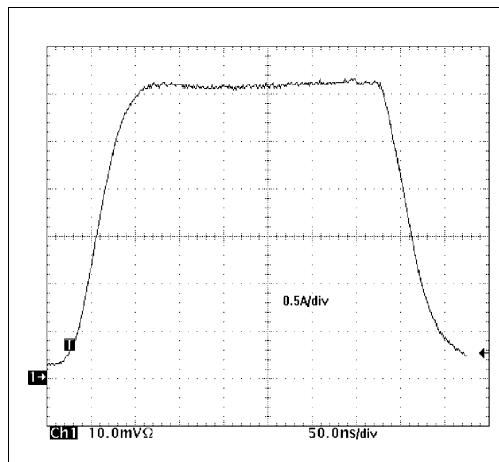
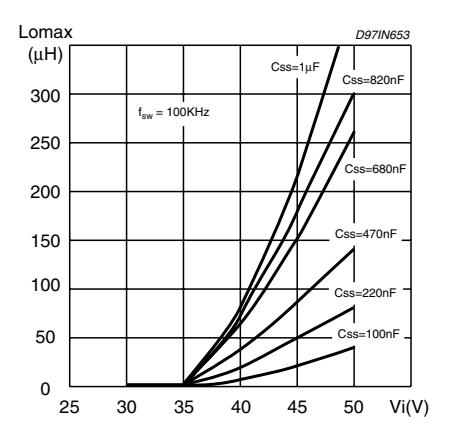
**Figure 31. Power dissipation vs. input voltage (device only)  
(see [Figure 6](#))**



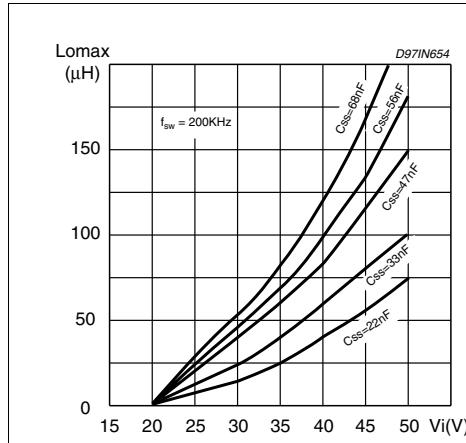
**Figure 32. Power dissipation vs. output voltage (device only)**

**Figure 33. Pulse by pulse limiting current vs. junction temperature**

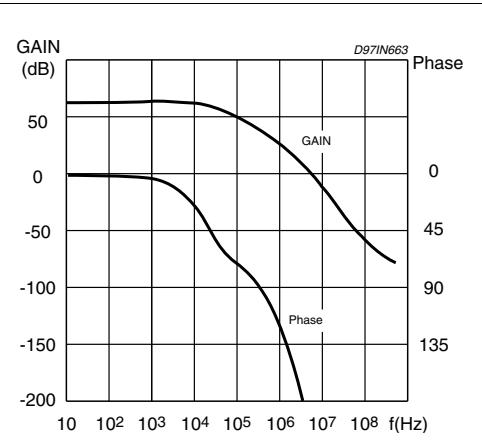


**Figure 34. Load transient****Figure 35. Line transient****Figure 36. Source current rise and fall time, pin 2, 3 (see Figure 3)****Figure 37. Soft start capacitor selection vs. inductor and  $V_{CC}$  max (ref. AN938)**

**Figure 38. Soft start capacitor selection vs. inductor and  $V_{CC}$  max (ref. AN938)**

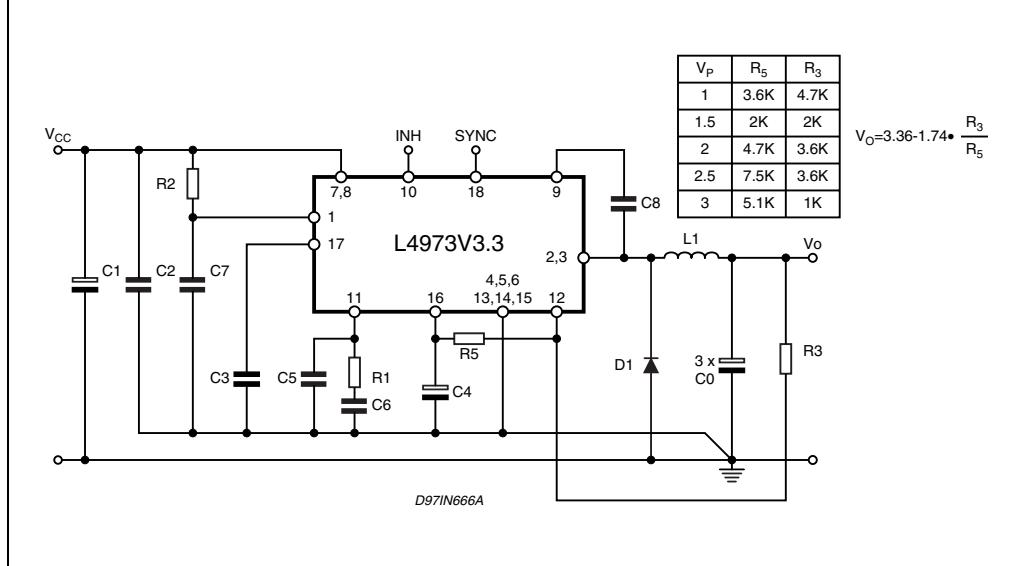


**Figure 39. Open loop frequency and phase of error amplifier**

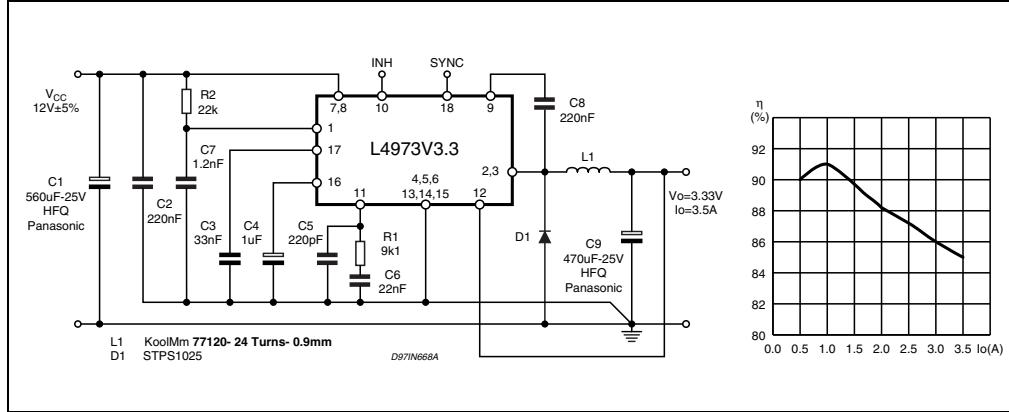


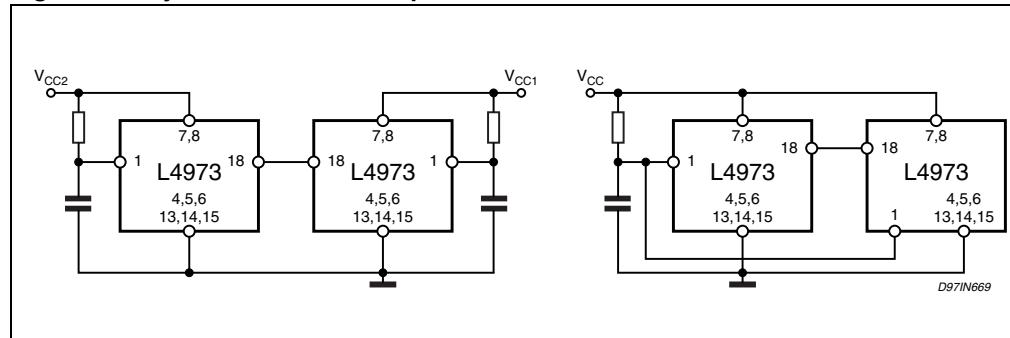
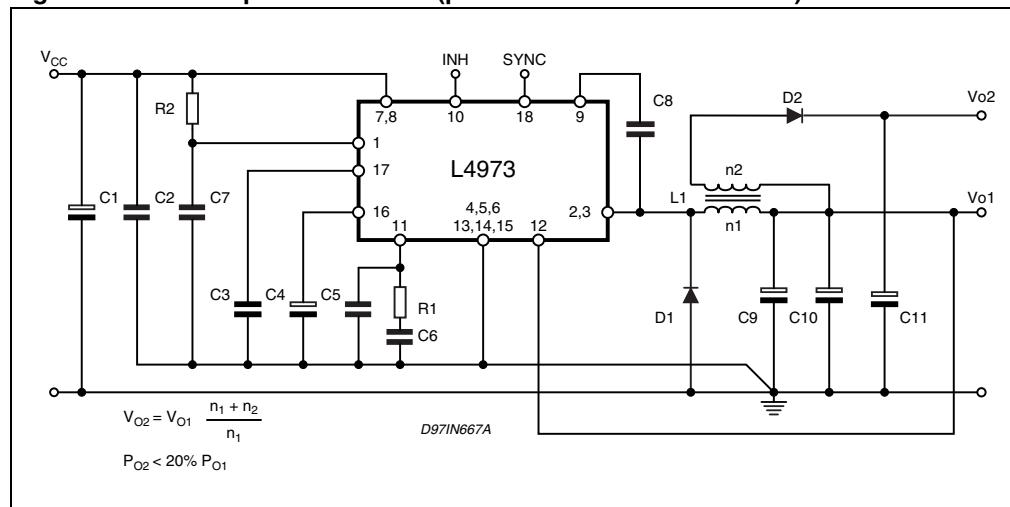
## 8 Application ideas

**Figure 40.** 3.5A at  $V_O < 3.3V$  (see part list [Figure 3](#))



**Figure 41.** 12V to 3.3V high performance buck converter ( $f_{sw} = 200\text{kHz}$ )



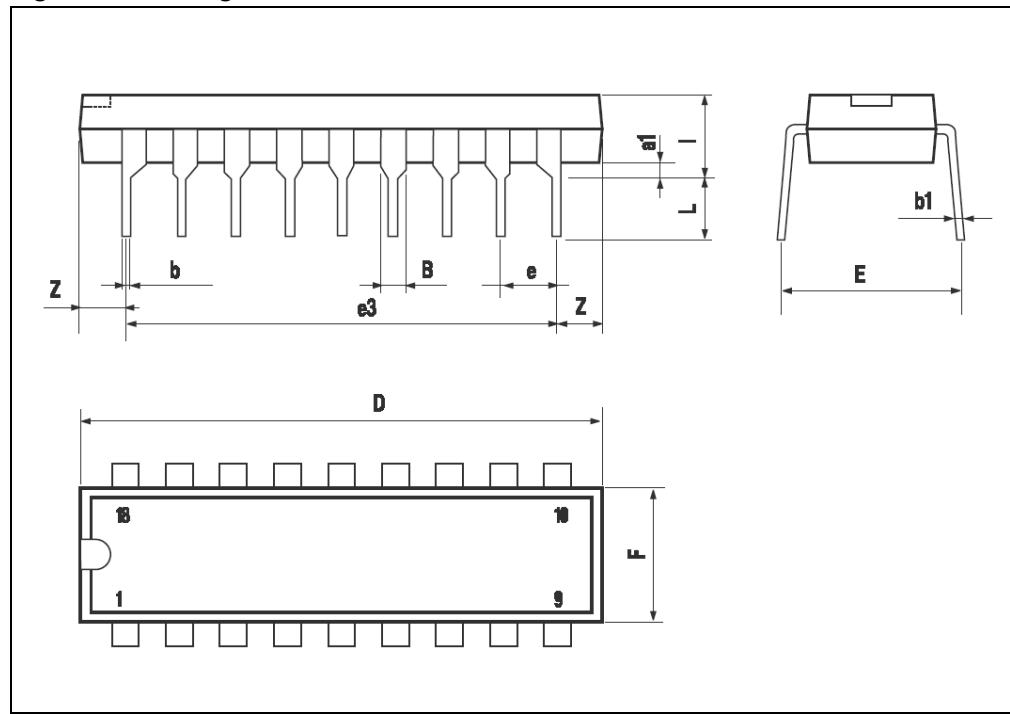
**Figure 42. Synchronization example****Figure 43. Multioutput not isolated (pin out referred to DIP12+3+3)**

## 9 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect . The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: [www.st.com](http://www.st.com)

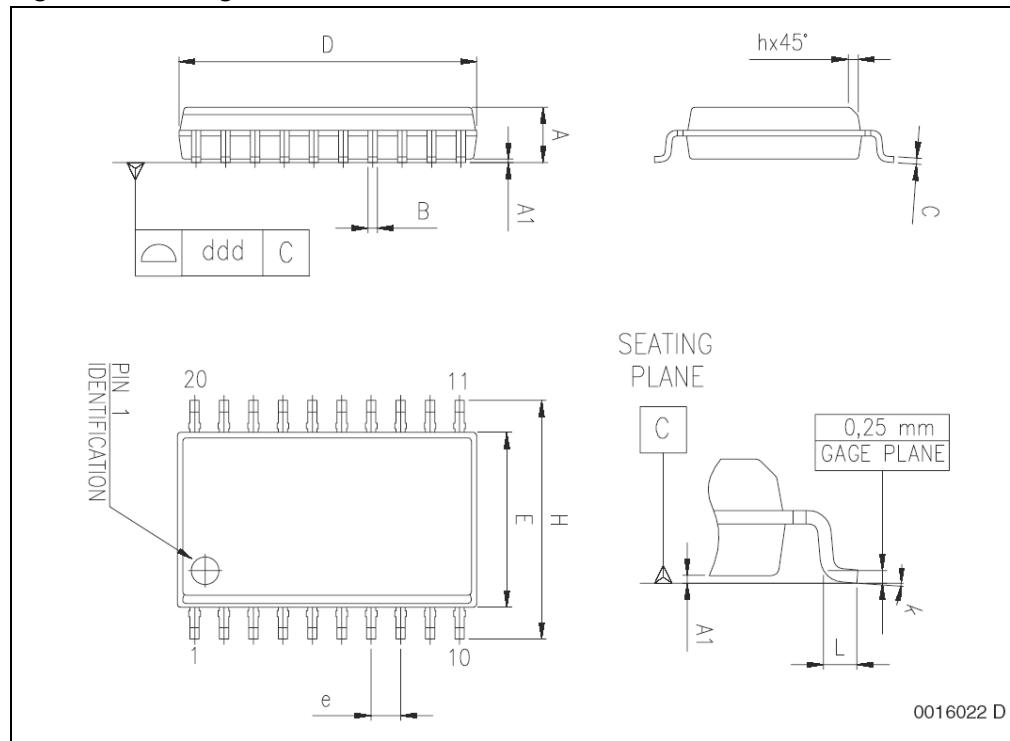
**Table 6. DIP-18 mechanical data**

Dim.	mm.			inch		
	Min	Typ	Max	Min	Typ	Max
a1	0.51			0.020		
B	0.85		1.40	0.033		0.055
b		0.50			0.020	
b1	0.38		0.50	0.015		0.020
D			24.80			0.976
E		8.80			0.346	
e		2.54			0.100	
e3		20.32			0.800	
F			7.10			0.280
I			5.10			0.201
L		3.30			0.130	
Z			2.54			0.100

**Figure 44. Package dimensions**

**Table 7. SO-20 mechanical data**

Dim.	mm.			inch		
	Min	Typ	Max	Min	Typ	Max
A	2.35		2.65	0.093		0.104
A1	0.10		0.30	0.004		0.012
B	0.33		0.51	0.013		0.200
C	0.23		0.32	0.009		0.013
D (1)	12.60		13.00	0.496		0.512
E	7.40		7.60	0.291		0.299
e		1.27			0.050	
H	10.0		10.65	0.394		0.419
h	0.25		0.75	0.010		0.030
L	0.40		1.27	0.016		0.050
k	0° (min.), 8° (max.)					
ddd			0.10			0.004

**Figure 45. Package dimensions**

## 10 Order code

**Table 8. Order code**

Part number	Package	Packaging
L4973D3.3, E-L4973D3.3	SO-20	Tube
L4973D3.3-013TR, E-L4973D3.3-TR	SO-20	Tape and reel
L4973D5.1	SO-20	Tube
L4973D5.1-013TR	SO-20	Tape and reel
L4973V3.3, E-L4973V3.3	DIP-18	Tube
L4973V5.1, E-L4973V5.1	DIP-18	Tube

## 11 Revision history

**Table 9. Revision history**

Date	Revision	Changes
12-Sep-2001	13	First Issue
07-May-2005	14	Updated the Layout look & feel. Changed name of the D1 on the fig. 5.
14-Dec-2005	15	Added the ECOPACK part numbers in the Table 1. Order Codes.
06-Dec-2006	16	The document has been reformatted, orderables updated

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